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For Immediate Release

Seika Machinery Highlights Smarter PCB Routing, Inspection, and Process Control at SMTA International

TORRANCE, CA — September 2026 — Seika Machinery, Inc., a leading provider of advanced machinery, materials and engineering services, will exhibit at SMTA International 2026, taking place October 27–29 at the Donald E. Stephens Convention Center in Rosemont, Illinois. Attendees are invited to visit Booth 2814 to explore a range of proven solutions for PCB routing, process control, inspection, and reliability testing.



Among the highlights will be the Sayaka SAM-CT34XJ router, a versatile platform designed for both in-line and stand-alone operation. The system features automatic fiducial recognition, QR code program loading, and optional automatic bit changing, delivering high precision with repeatability of ± 0.01 mm while supporting efficient, low-maintenance operation.

Seika will also feature the Malcom PCU-285 viscometer, the latest evolution in solder paste viscosity measurement. Equipped with an onboard PC and touchscreen interface, the system enables automatic measurement, data storage, and network connectivity, while maintaining compliance with JIS Z3284 standards for thixotropic index and viscosity recovery analysis.

Process optimization solutions will include the Malcom RCX profiler system, which provides real-time thermal profiling for reflow processes, helping manufacturers fine-tune oven performance and improve solder joint quality.

For cleaning applications, the Unitech PCB cleaner will be on display, designed to accommodate large board sizes while delivering thorough and consistent cleaning for demanding assemblies.

Seika's booth will also feature advanced inspection and analysis technologies, including the Morita Tech WM7000 series EMC Noise Scanner, used to visualize and analyze electromagnetic emissions during product development and validation. In addition, Kyowa strain gage systems will be showcased for measuring mechanical stress across critical assembly processes such as reflow, ICT, functional testing, and depaneling.

Also featured is the Sawa T100 automatic stencil inspection system, which provides fast, repeatable aperture inspection to support print quality and process consistency.



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Together, these solutions reflect Seika Machinery's focus on helping electronics manufacturers improve process control, product quality, and production efficiency across the entire assembly line.

Visit Booth 2814 to learn how Seika Machinery supports smarter, more reliable electronics manufacturing.

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About Seika Machinery, Inc.

Seika Machinery, Inc. (SMI) is a subsidiary of Seika Corporation, Japan and member of the Mitsubishi Global Group. SMI provides electronics manufacturers with advanced machinery, superior materials and engineering services.